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AMENDMENT TRANSMITTAL LETTER (Large Entity)APR 1 Applicant(s): Paul Rich						Docket No. WLJ.0099		
Application No. 10/760,464	Filing Date 01/21/2004	Examiner McDonald, Rodney Glenn		Customer 20987	i G	roup Art Un 1753	Confirmation No.	
Invention: ELECTROSTATIC CLAMPING OF THIN WAFERS IN PLASMA								
COMMISSIONER FOR PATENTS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.								
CLAIMS AS AMENDED								
	CLAIMS REMAINING	HIGHEST #	Τ	R EXTRA	RATE		ADDITIONAL	
TOTAL CLAIMS	AFTER AMENDMENT 8 -	PREV. PAID FOR	CLAIMS	PRESENT		\$50.00	FEE	
INDEP. CLAIMS	2 -	3 =		0	x	\$50.00 \$200.00	\$0.00 \$0.00	
Multiple Dependent Claims (check if applicable)				U		\$200.00	\$0.00	
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$0.00								
No additional fee is required for amendment. □ Please charge Deposit Account No. in the amount of □ A check in the amount of to cover the filling fee is enclosed. □ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-0238 □ Any additional filing fees required under 37 C.F.R. 1.16. □ Any patent application processing fees under 37 CFR 1.17. □ Payment by credit card. Form PTO-2038. WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038. Dated: APRIL 19, 2007								
ADAM C. VOLEI REG. NO. 33289 VOLENTINE & V 11951 FREEDOM RESTON VA 2019 TEL. 571.283.0720	WHITT, PLLC I DRIVE, SUITE 1260 90	·	the Uni	ted States Po ail in an envel ox 1450, Alexa (Date)	ostal S lope ad ndria, \	ervice with su dressed to "Co	is being deposited with fficient postage as first emmissioner for Patents, " [37 CFR 1.8(a)] on	
				Typed or Printed Name of Person Mailing Correspondence				



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of

Paul Rich : Group Art Unit 1753

Application No. 10/760,464 : Examiner McDonald, Rodney Glenn

Filed January 21, 2004 :

ELECTROSTATIC CLAMPING OF THIN WAFERS IN PLASMA PROCESSING VACUUM CLEANER

AMENDMENT

U.S. Patent and Trademark Office

Customer Window, Mail Stop Amendment

Randolph Building

401 Dulany Street

Alexandria, VA 22314

Sir:

In response to the Office Action dated February 16, 2007, please amend the above-identified application as follows:

Amendments to the Drawings begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.